

KIOXIA CM7-V Series (2.5-inch)

(KCMY1VUG/KCMYXVUG/KCMYDVUG/KCMYFVUG)

Enterprise NVMe™ Mixed-use SSD

KIOXIA CM7-V Series is a mixed-use SSD that is optimized to support a broad range of enterprise applications and associated workloads, including high performance computing, online transaction processing, IoT and edge computing, media streaming. Built on PCIe® 5.0 (for U.3 host: PCIe® 4.0) and NVMe™ 2.0 technology, the CM7 Series SSDs deliver excellent performance up to 2,700K IOPS (random read) and 600K IOPS (random write).

Featuring KIOXIA 112-layer BiCS FLASH™ 3D TLC flash memory, the CM7-V Series of enterprise NVMe™ SSDs delivers 3 DWPD (Drive Writes Per Day) of endurance and supports storage capacities up to 12.8 TB, making them ideally suited for read and write mixed-use enterprise applications.



Product image may represent a design model.

Key Features

- PCIe® 5.0 (for U.3 host: PCIe® 4.0), NVMe™ 2.0 specification compliant
- Open Compute Project Datacenter NVMe™ SSD specification v2.0 support (not all requirements)
- Form factor: 2.5-inch, 15 mm thickness
- Proprietary KIOXIA architecture: controller, firmware and 112-layer BiCS FLASH™ 3D TLC
- SFF-TA-1001 conformant (U.3)
- Dual-port design for high availability applications
- High performance with lower power consumption
- Power loss protection (PLP) and end-to-end data protection
- Suited for 24x7 enterprise workloads
- Security options: SIE, SED, FIPS SED [1, 2, 3, 4, 5]

Key Applications

- Software defined storage and virtualization
- Data warehousing
- Online transaction processing (OLTP) (transactional and relational databases)
- Business intelligence
- Artificial intelligence and machine learning

Specifications

Base Model Number	KCMY1VUG12T8	KCMY1VUG6T40	KCMY1VUG3T20	KCMY1VUG1T60
SIE Model Number	KCMYXVUG12T8	KCMYXVUG6T40	KCMYXVUG3T20	KCMYXVUG1T60
SED Model Number	KCMYDVUG12T8	KCMYDVUG6T40	KCMYDVUG3T20	KCMYDVUG1T60
FIPS SED Model Number	KCMYFVUG12T8	KCMYFVUG6T40	KCMYFVUG3T20	KCMYFVUG1T60
Capacity	12,800 GB	6,400 GB	3,200 GB	1,600 GB
Basic Specifications				
Form Factor	2.5-inch, 15 mm thickness			
Interface	PCIe® 5.0, NVMe™ 2.0			
Maximum Interface Speed	128 GT/s (PCIe® Gen5 single x4, dual x2)			
Flash Memory Type	BiCS FLASH™ TLC			

Specifications (Continued)

Capacity	12,800 GB	6,400 GB	3,200 GB	1,600 GB
Performance in single port (1x4) mode (Up to)				
Sustained 128 KiB Sequential Read	14,000 MB/s			
Sustained 128 KiB Sequential Write	7,000 MB/s	6,750 MB/s		3,500 MB/s
Sustained 4 KiB Random Read	2,400K IOPS	2,450K IOPS	2,700K IOPS	2,000K IOPS
Sustained 4 KiB Random Write	550K IOPS		600K IOPS	310K IOPS
Power Requirements				
Supply Voltage	12 V ± 10 %, 3.3 V ± 15 %			
Power Consumption (Active)	25 W typ.			22 W typ.
Power Consumption (Ready)	5 W typ.			
Reliability				
MTTF	2,500,000 hours			
Warranty	5 years			
DWPD	3			
Dimensions				
Thickness	15.0 mm +0 / -0.5 mm			
Width	69.85 mm ± 0.25 mm			
Length	100.45 mm Max			
Weight	130 g Max			
Environmental				
Temperature (Operating)	0 °C to 73 °C		0 °C to 76 °C	
Temperature (Non-operating)	-40 °C to 85 °C			
Humidity (Operating)	5 % to 95 % R.H.			
Vibration (Operating)	21.27 m/s² { 2.17 Grms } (5 to 800 Hz)			
Shock (Operating)	9.8 km/s² { 1,000 G } (0.5 ms)			

Definition of capacity: KIOXIA Corporation defines a megabyte (MB) as 1,000,000 bytes, a gigabyte (GB) as 1,000,000,000 bytes and a terabyte (TB) as 1,000,000,000,000 bytes. A computer operating system, however, reports storage capacity using powers of 2 for the definition of 1GB = 2³⁰ = 1,073,741,824 bytes and therefore shows less storage capacity. Available storage capacity (including examples of various media files) will vary based on file size, formatting, settings, software and operating system, and/or pre-installed software applications, or media content. Actual formatted capacity may vary.

GT/s: Giga Transfers per second.

A kibibyte (KiB) means 2¹⁰, or 1,024 bytes.

MTTF (Mean Time to Failure) is not a guarantee or estimate of product life; it is a statistical value related to mean failure rates for a large number of products which may not accurately reflect actual operation. Actual operating life of the product may be different from the MTTF.

DWPD: Drive Writes Per Day. One full drive write per day means the drive can be written and re-written to full capacity once a day every day for the specified lifetime. Actual results may vary due to system configuration, usage and other factors.

Read and write speed may vary depending on various factors such as host devices, software (drivers, OS etc.), and read/write conditions.

IOPS: Input Output Per Second (or the number of I/O operations per second).

Temperature (operating): Specified by the composite temperature reported by SMART.

[1] The Sanitize Instant Erase (SIE), Self-Encrypting Drive (SED) and FIPS (Federal Information Processing Standards) SED optional models are available.

[2] SIE optional models support Crypto Erase, which is a standardized feature defined by the technical committees (T10) of INCITS (the InterNational Committee for Information Technology Standards).

[3] SED optional models support TCG Opal and Ruby SSCs. It has a few unsupported TCG Opal features. For more details, please make inquiries through "Contact us" in each region's website, <https://www.kioxia.com/>.

[4] FIPS SED optional models utilize a security module designed to comply with FIPS 140-3, which define security requirements for cryptographic module by NIST (National Institute of Standards and Technology). For the latest validation status, please make inquiries through "Contact us" in each region's website, <https://www.kioxia.com/>.

[5] Optional security feature compliant models are not available in all countries due to export and local regulations.

All information provided in this catalog is subject to change without any prior notice. For the latest and detail specification, please send an inquiry through "Contact us" in each region's website, <https://www.kioxia.com/>.

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